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### Understanding [Embedded - Microprocessors](#)

Embedded microprocessors are specialized computing chips designed to perform specific tasks within an embedded system. Unlike general-purpose microprocessors found in personal computers, embedded microprocessors are tailored for dedicated functions within larger systems, offering optimized performance, efficiency, and reliability. These microprocessors are integral to the operation of countless electronic devices, providing the computational power necessary for controlling processes, handling data, and managing communications.

### Applications of [Embedded - Microprocessors](#)

Embedded microprocessors are utilized across a broad spectrum of applications, making them indispensable in

#### Details

|                                 |                                                                                                                                                             |
|---------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Product Status                  | Obsolete                                                                                                                                                    |
| Core Processor                  | PowerPC e300                                                                                                                                                |
| Number of Cores/Bus Width       | 1 Core, 32-Bit                                                                                                                                              |
| Speed                           | 533MHz                                                                                                                                                      |
| Co-Processors/DSP               | Security; SEC                                                                                                                                               |
| RAM Controllers                 | DDR                                                                                                                                                         |
| Graphics Acceleration           | No                                                                                                                                                          |
| Display & Interface Controllers | -                                                                                                                                                           |
| Ethernet                        | 10/100/1000Mbps (2)                                                                                                                                         |
| SATA                            | -                                                                                                                                                           |
| USB                             | USB 2.0 + PHY (2)                                                                                                                                           |
| Voltage - I/O                   | 2.5V, 3.3V                                                                                                                                                  |
| Operating Temperature           | 0°C ~ 105°C (TA)                                                                                                                                            |
| Security Features               | Cryptography, Random Number Generator                                                                                                                       |
| Package / Case                  | 672-LBGA                                                                                                                                                    |
| Supplier Device Package         | 672-LBGA (35x35)                                                                                                                                            |
| Purchase URL                    | <a href="https://www.e-xfl.com/product-detail/nxp-semiconductors/kmpc8347ezuajf">https://www.e-xfl.com/product-detail/nxp-semiconductors/kmpc8347ezuajf</a> |

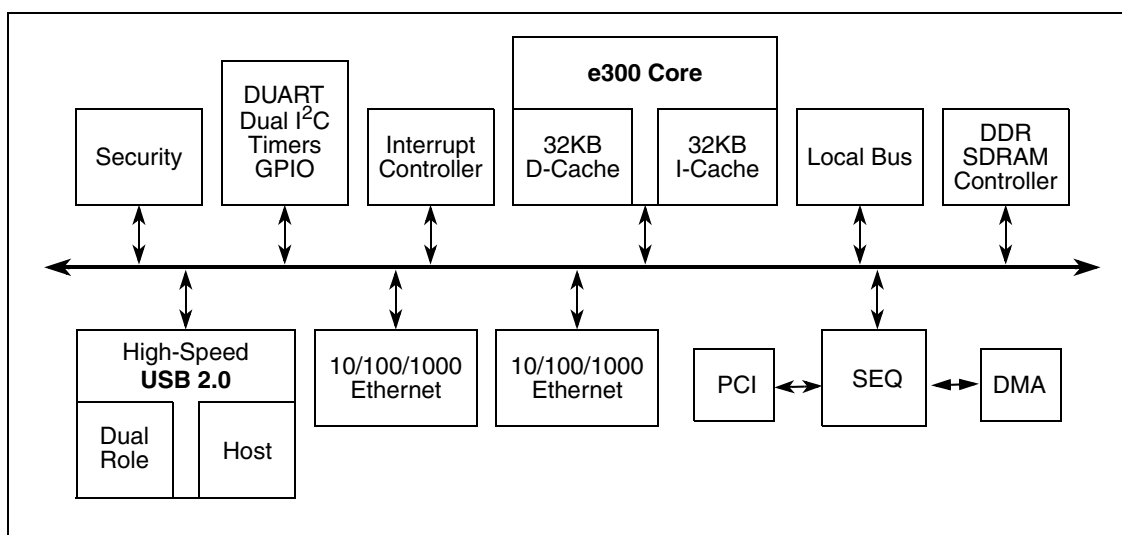
## NOTE

The information in this document is accurate for revision 3.x silicon and later (in other words, for orderable part numbers ending in A or B). For information on revision 1.1 silicon and earlier versions, see the *MPC8347E PowerQUICC II Pro Integrated Host Processor Hardware Specifications*.

See [Section 22.1, “Part Numbers Fully Addressed by This Document,”](#) for silicon revision level determination.

# 1 Overview

This section provides a high-level overview of the device features. [Figure 1](#) shows the major functional units within the MPC8347EA.



**Figure 1. MPC8347EA Block Diagram**

Major features of the device are as follows:

- Embedded PowerPC e300 processor core; operates at up to 667 MHz
  - High-performance, superscalar processor core
  - Floating-point, integer, load/store, system register, and branch processing units
  - 32-Kbyte instruction cache, 32-Kbyte data cache
  - Lockable portion of L1 cache
  - Dynamic power management
  - Software-compatible with the other Freescale processor families that implement Power Architecture technology
- Double data rate, DDR1/DDR2 SDRAM memory controller
  - Programmable timing supporting DDR1 and DDR2 SDRAM
  - 32- or 64-bit data interface, up to 400 MHz data rate for TBGA, 266 MHz for PBGA

- Up to four physical banks (chip selects), each bank up to 1 Gbyte independently addressable
- DRAM chip configurations from 64 Mbits to 1 Gbit with  $\times 8/\times 16$  data ports
- Full error checking and correction (ECC) support
- Support for up to 16 simultaneous open pages (up to 32 pages for DDR2)
- Contiguous or discontiguous memory mapping
- Read-modify-write support
- Sleep-mode support for SDRAM self refresh
- Auto refresh
- On-the-fly power management using CKE
- Registered DIMM support
- 2.5-V SSTL2 compatible I/O for DDR1, 1.8-V SSTL2 compatible I/O for DDR2
- Dual three-speed (10/100/1000) Ethernet controllers (TSECs)
  - Dual controllers designed to comply with IEEE 802.3™, 802.3u™, 802.3x™, 802.3z™, 802.3ac™ standards
  - Ethernet physical interfaces:
    - 1000 Mbps IEEE Std. 802.3 GMII/RGMII, IEEE Std. 802.3z TBI/RTBI, full-duplex
    - 10/100 Mbps IEEE Std. 802.3 MII full- and half-duplex
  - Buffer descriptors are backward-compatible with MPC8260 and MPC860T 10/100 programming models
  - 9.6-Kbyte jumbo frame support
  - RMON statistics support
  - Internal 2-Kbyte transmit and 2-Kbyte receive FIFOs per TSEC module
  - MII management interface for control and status
  - Programmable CRC generation and checking
- PCI interface
  - Designed to comply with *PCI Specification Revision 2.3*
  - Data bus width:
    - 32-bit data PCI interface operating at up to 66 MHz
  - PCI 3.3-V compatible
  - PCI host bridge capabilities
  - PCI agent mode on PCI interface
  - PCI-to-memory and memory-to-PCI streaming
  - Memory prefetching of PCI read accesses and support for delayed read transactions
  - Posting of processor-to-PCI and PCI-to-memory writes
  - On-chip arbitration supporting five masters on PCI
  - Accesses to all PCI address spaces
  - Parity supported
  - Selectable hardware-enforced coherency

- Address translation units for address mapping between host and peripheral
- Dual address cycle for target
- Internal configuration registers accessible from PCI
- Security engine is optimized to handle all the algorithms associated with IPSec, SSL/TLS, SRTP, IEEE Std. 802.11i®, iSCSI, and IKE processing. The security engine contains four crypto-channels, a controller, and a set of crypto execution units (EUs):
  - Public key execution unit (PKEU) :
    - RSA and Diffie-Hellman algorithms
    - Programmable field size up to 2048 bits
    - Elliptic curve cryptography
    - F2m and F(p) modes
    - Programmable field size up to 511 bits
  - Data encryption standard (DES) execution unit (DEU)
    - DES and 3DES algorithms
    - Two key (K1, K2) or three key (K1, K2, K3) for 3DES
    - ECB and CBC modes for both DES and 3DES
  - Advanced encryption standard unit (AESU)
    - Implements the Rijndael symmetric-key cipher
    - Key lengths of 128, 192, and 256 bits
    - ECB, CBC, CCM, and counter (CTR) modes
  - XOR parity generation accelerator for RAID applications
  - ARC four execution unit (AFEU)
    - Stream cipher compatible with the RC4 algorithm
    - 40- to 128-bit programmable key
  - Message digest execution unit (MDEU)
    - SHA with 160-, 224-, or 256-bit message digest
    - MD5 with 128-bit message digest
    - HMAC with either algorithm
  - Random number generator (RNG)
  - Four crypto-channels, each supporting multi-command descriptor chains
    - Static and/or dynamic assignment of crypto-execution units through an integrated controller
    - Buffer size of 256 bytes for each execution unit, with flow control for large data sizes
- Universal serial bus (USB) dual role controller
  - USB on-the-go mode with both device and host functionality
  - Complies with USB specification Rev. 2.0
  - Can operate as a stand-alone USB device
    - One upstream facing port
    - Six programmable USB endpoints

## 2.1.2 Power Supply Voltage Specification

Table 2 provides the recommended operating conditions for the MPC8347EA. Note that the values in Table 2 are the recommended and tested operating conditions. Proper device operation outside these conditions is not guaranteed.

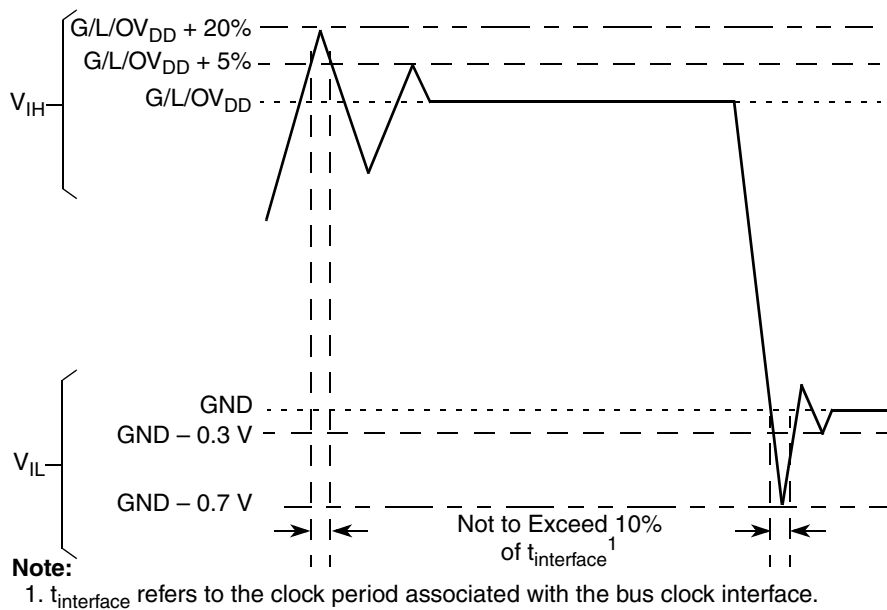
**Table 2. Recommended Operating Conditions**

| Parameter                                                                                          | Symbol     | Recommended Value                                                        | Unit | Notes |
|----------------------------------------------------------------------------------------------------|------------|--------------------------------------------------------------------------|------|-------|
| Core supply voltage for 667-MHz core frequency                                                     | $V_{DD}$   | $1.3 \text{ V} \pm 60 \text{ mV}$                                        | V    | 1     |
| Core supply voltage                                                                                | $V_{DD}$   | $1.2 \text{ V} \pm 60 \text{ mV}$                                        | V    | 1     |
| PLL supply voltage for 667-MHz core frequency                                                      | $AV_{DD}$  | $1.3 \text{ V} \pm 60 \text{ mV}$                                        | V    | 1     |
| PLL supply voltage                                                                                 | $AV_{DD}$  | $1.2 \text{ V} \pm 60 \text{ mV}$                                        | V    | 1     |
| DDR and DDR2 DRAM I/O voltage                                                                      | $GV_{DD}$  | $2.5 \text{ V} \pm 125 \text{ mV}$<br>$1.8 \text{ V} \pm 90 \text{ mV}$  | V    | —     |
| Three-speed Ethernet I/O supply voltage                                                            | $LV_{DD1}$ | $3.3 \text{ V} \pm 330 \text{ mV}$<br>$2.5 \text{ V} \pm 125 \text{ mV}$ | V    | —     |
| Three-speed Ethernet I/O supply voltage                                                            | $LV_{DD2}$ | $3.3 \text{ V} \pm 330 \text{ mV}$<br>$2.5 \text{ V} \pm 125 \text{ mV}$ | V    | —     |
| PCI, local bus, DUART, system control and power management, I <sup>2</sup> C, and JTAG I/O voltage | $OV_{DD}$  | $3.3 \text{ V} \pm 330 \text{ mV}$                                       | V    | —     |

**Note:**

<sup>1</sup>  $GV_{DD}$ ,  $LV_{DD}$ ,  $OV_{DD}$ ,  $AV_{DD}$ , and  $V_{DD}$  must track each other and must vary in the same direction—either in the positive or negative direction.

Figure 2 shows the undershoot and overshoot voltages at the interfaces of the MPC8347EA.



**Figure 2. Overshoot/Undershoot Voltage for  $GV_{DD}/OV_{DD}/LV_{DD}$**

**Table 20. DDR and DDR2 SDRAM Output AC Timing Specifications (continued)**

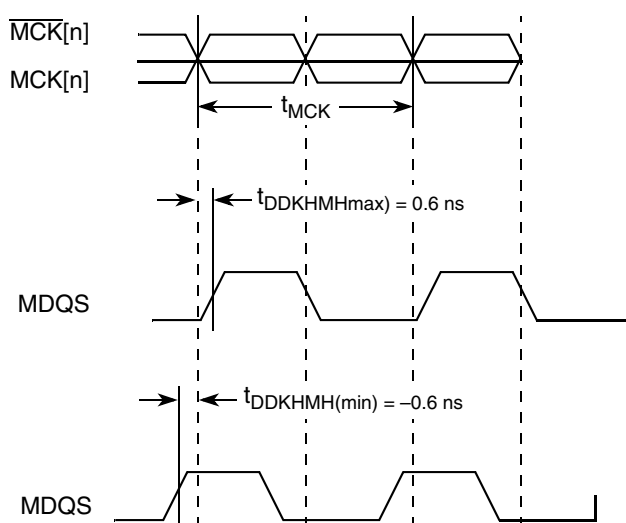
At recommended operating conditions with  $GV_{DD}$  of (1.8 or 2.5 V)  $\pm$  5%.

| Parameter           | Symbol <sup>1</sup> | Min                         | Max                         | Unit | Notes |
|---------------------|---------------------|-----------------------------|-----------------------------|------|-------|
| 266 MHz             |                     | 1100                        | —                           |      |       |
| 200 MHz             |                     | 1200                        | —                           |      |       |
| MDQS preamble start | $t_{DDKHMP}$        | $-0.5 \times t_{MCK} - 0.6$ | $-0.5 \times t_{MCK} + 0.6$ | ns   | 6     |
| MDQS epilogue end   | $t_{DDKHME}$        | -0.6                        | 0.6                         | ns   | 6     |

**Notes:**

1. The symbols for timing specifications follow the pattern of  $t_{(first\ two\ letters\ of\ functional\ block)(signal)(state)(reference)(state)}$  for inputs and  $t_{(first\ two\ letters\ of\ functional\ block)(reference)(state)(signal)(state)}$  for outputs. Output hold time can be read as DDR timing (DD) from the rising or falling edge of the reference clock (KH or KL) until the output goes invalid (AX or DX). For example,  $t_{DDKHAS}$  symbolizes DDR timing (DD) for the time  $t_{MCK}$  memory clock reference (K) goes from the high (H) state until outputs (A) are set up (S) or output valid time. Also,  $t_{DDKLDX}$  symbolizes DDR timing (DD) for the time  $t_{MCK}$  memory clock reference (K) goes low (L) until data outputs (D) are invalid (X) or data output hold time.
2. All MCK/ $\overline{MCK}$  referenced measurements are made from the crossing of the two signals  $\pm 0.1$  V.
3. ADDR/CMD includes all DDR SDRAM output signals except MCK/ $\overline{MCK}$ ,  $\overline{MCS}$ , and MDQ/MECC/MDM/MDQS. For the ADDR/CMD setup and hold specifications, it is assumed that the clock control register is set to adjust the memory clocks by 1/2 applied cycle.
4.  $t_{DDKHMH}$  follows the symbol conventions described in note 1. For example,  $t_{DDKHMH}$  describes the DDR timing (DD) from the rising edge of the MCK(n) clock (KH) until the MDQS signal is valid (MH).  $t_{DDKHMH}$  can be modified through control of the DQSS override bits in the TIMING\_CFG\_2 register and is typically set to the same delay as the clock adjust in the CLK\_CNTL register. The timing parameters listed in the table assume that these two parameters are set to the same adjustment value. See the *MPC8349EA PowerQUICC II Pro Integrated Host Processor Family Reference Manual* for the timing modifications enabled by use of these bits.
5. Determined by maximum possible skew between a data strobe (MDQS) and any corresponding bit of data (MDQ), ECC (MECC), or data mask (MDM). The data strobe should be centered inside the data eye at the pins of the microprocessor.
6. All outputs are referenced to the rising edge of MCK(n) at the pins of the microprocessor. Note that  $t_{DDKHMP}$  follows the symbol conventions described in note 1.

Figure 6 shows the DDR SDRAM output timing for the MCK to MDQS skew measurement ( $t_{DDKHMH}$ ).


**Figure 6. Timing Diagram for  $t_{DDKHMH}$**

**Table 27. MII Transmit AC Timing Specifications (continued)**

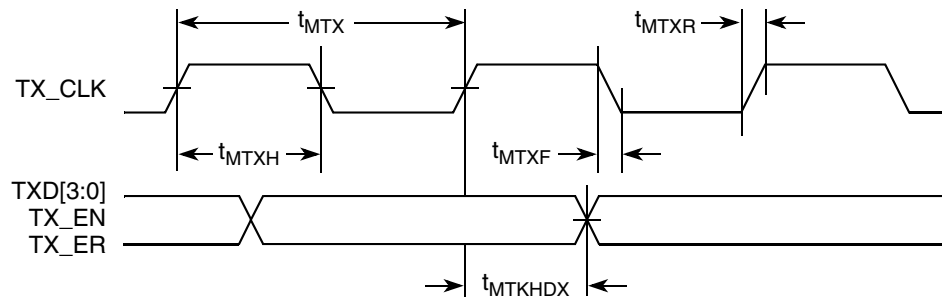
At recommended operating conditions with  $V_{DD}/OV_{DD}$  of 3.3 V  $\pm$  10%.

| Parameter/Condition              | Symbol <sup>1</sup> | Min | Typ | Max | Unit |
|----------------------------------|---------------------|-----|-----|-----|------|
| TX_CLK data clock rise (20%–80%) | $t_{MTXR}$          | 1.0 | —   | 4.0 | ns   |
| TX_CLK data clock fall (80%–20%) | $t_{MTXF}$          | 1.0 | —   | 4.0 | ns   |

**Note:**

- The symbols for timing specifications follow the pattern of  $t_{(first\ two\ letters\ of\ functional\ block)(signal)(state)(reference)(state)}$  for inputs and  $t_{(first\ two\ letters\ of\ functional\ block)(reference)(state)(signal)(state)}$  for outputs. For example,  $t_{MTKHDX}$  symbolizes MII transmit timing (MT) for the time  $t_{MTX}$  clock reference (K) going high (H) until data outputs (D) are invalid (X). In general, the clock reference symbol is based on two to three letters representing the clock of a particular function. For example, the subscript of  $t_{MTX}$  represents the MII(M) transmit (TX) clock. For rise and fall times, the latter convention is used with the appropriate letter: R (rise) or F (fall).

Figure 11 shows the MII transmit AC timing diagram.


**Figure 11. MII Transmit AC Timing Diagram**

### 8.2.2.2 MII Receive AC Timing Specifications

Table 28 provides the MII receive AC timing specifications.

**Table 28. MII Receive AC Timing Specifications**

At recommended operating conditions with  $V_{DD}/OV_{DD}$  of 3.3 V  $\pm$  10%.

| Parameter/Condition                         | Symbol <sup>1</sup> | Min  | Typ | Max | Unit |
|---------------------------------------------|---------------------|------|-----|-----|------|
| RX_CLK clock period 10 Mbps                 | $t_{MRX}$           | —    | 400 | —   | ns   |
| RX_CLK clock period 100 Mbps                | $t_{MRX}$           | —    | 40  | —   | ns   |
| RX_CLK duty cycle                           | $t_{MRXH}/t_{MRXF}$ | 35   | —   | 65  | %    |
| RXD[3:0], RX_DV, RX_ER setup time to RX_CLK | $t_{MRDVKH}$        | 10.0 | —   | —   | ns   |
| RXD[3:0], RX_DV, RX_ER hold time to RX_CLK  | $t_{MRDXKH}$        | 10.0 | —   | —   | ns   |

Figure 18 and Figure 19 provide the AC test load and signals for the USB, respectively.

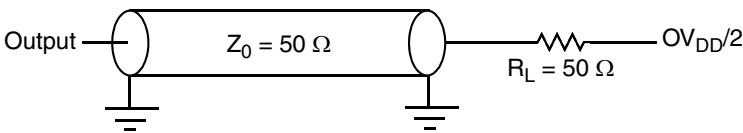


Figure 18. USB AC Test Load

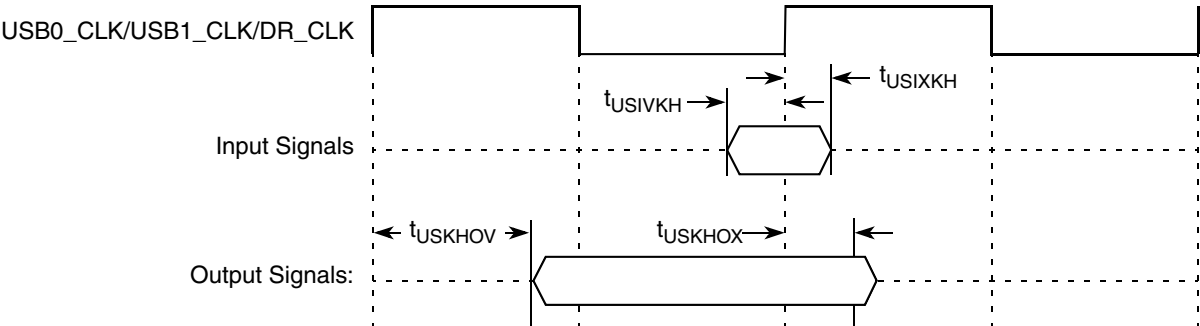


Figure 19. USB Signals

# 10 Local Bus

This section describes the DC and AC electrical specifications for the local bus interface of the MPC8347EA.

## 10.1 Local Bus DC Electrical Characteristics

Table 37 provides the DC electrical characteristics for the local bus interface.

Table 37. Local Bus DC Electrical Characteristics

| Parameter                                                     | Symbol   | Min             | Max             | Unit |
|---------------------------------------------------------------|----------|-----------------|-----------------|------|
| High-level input voltage                                      | $V_{IH}$ | 2               | $OV_{DD} + 0.3$ | V    |
| Low-level input voltage                                       | $V_{IL}$ | -0.3            | 0.8             | V    |
| Input current                                                 | $I_{IN}$ | —               | ±5              | μA   |
| High-level output voltage, $I_{OH} = -100\text{ }\mu\text{A}$ | $V_{OH}$ | $OV_{DD} - 0.2$ | —               | V    |
| Low-level output voltage, $I_{OL} = 100\text{ }\mu\text{A}$   | $V_{OL}$ | —               | 0.2             | V    |



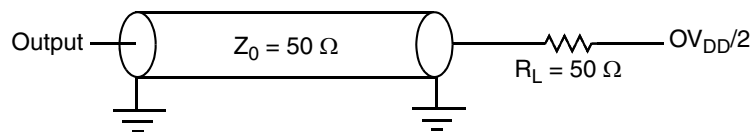
**Table 39. Local Bus General Timing Parameters—DLL Bypass<sup>9</sup>**

| Parameter                                                   | Symbol <sup>1</sup> | Min | Max | Unit | Notes |
|-------------------------------------------------------------|---------------------|-----|-----|------|-------|
| Local bus cycle time                                        | $t_{LBK}$           | 15  | —   | ns   | 2     |
| Input setup to local bus clock                              | $t_{LBIVKH}$        | 7   | —   | ns   | 3, 4  |
| Input hold from local bus clock                             | $t_{LBIXKH}$        | 1.0 | —   | ns   | 3, 4  |
| LALE output fall to LAD output transition (LATCH hold time) | $t_{LBOTOT1}$       | 1.5 | —   | ns   | 5     |
| LALE output fall to LAD output transition (LATCH hold time) | $t_{LBOTOT2}$       | 3   | —   | ns   | 6     |
| LALE output fall to LAD output transition (LATCH hold time) | $t_{LBOTOT3}$       | 2.5 | —   | ns   | 7     |
| Local bus clock to output valid                             | $t_{LBKLOV}$        | —   | 3   | ns   | 3     |
| Local bus clock to output high impedance for LAD/LDP        | $t_{LBKHOZ}$        | —   | 4   | ns   | 8     |

**Notes:**

1. The symbols for timing specifications follow the pattern of  $t_{(\text{first two letters of functional block})(\text{signal})(\text{state})(\text{reference})(\text{state})}$  for inputs and  $t_{(\text{first two letters of functional block})(\text{reference})(\text{state})(\text{signal})(\text{state})}$  for outputs. For example,  $t_{LBIXKH1}$  symbolizes local bus timing (LB) for the input (I) to go invalid (X) with respect to the time the  $t_{LBK}$  clock reference (K) goes high (H), in this case for clock one (1). Also,  $t_{LBKHOX}$  symbolizes local bus timing (LB) for the  $t_{LBK}$  clock reference (K) to go high (H), with respect to the output (O) going invalid (X) or output hold time.
2. All timings are in reference to the falling edge of LCLK0 (for all outputs and for  $\overline{LGTA}$  and LUPWAIT inputs) or the rising edge of LCLK0 (for all other inputs).
3. All signals are measured from  $OV_{DD}/2$  of the rising/falling edge of LCLK0 to  $0.4 \times OV_{DD}$  of the signal in question for 3.3 V signaling levels.
4. Input timings are measured at the pin.
5.  $t_{LBOTOT1}$  should be used when RCWH[LALE] is set and when the load on the LALE output pin is at least 10 pF less than the load on the LAD output pins.
6.  $t_{LBOTOT2}$  should be used when RCWH[LALE] is not set and when the load on the LALE output pin is at least 10 pF less than the load on the LAD output pins.
7.  $t_{LBOTOT3}$  should be used when RCWH[LALE] is not set and when the load on the LALE output pin equals to the load on the LAD output pins.
8. For purposes of active/float timing measurements, the Hi-Z or off-state is defined to be when the total current delivered through the component pin is less than or equal to the leakage current specification.
9. DLL bypass mode is not recommended for use at frequencies above 66 MHz.

Figure 20 provides the AC test load for the local bus.


**Figure 20. Local Bus C Test Load**

**Table 43. I<sup>2</sup>C AC Electrical Specifications (continued)**

| Parameter                                                                       | Symbol <sup>1</sup> | Min                  | Max | Unit    |
|---------------------------------------------------------------------------------|---------------------|----------------------|-----|---------|
| Fall time of both SDA and SCL signals <sup>5</sup>                              | $t_{I2CF}$          | —                    | 300 | ns      |
| Setup time for STOP condition                                                   | $t_{I2PVKH}$        | 0.6                  | —   | $\mu$ s |
| Bus free time between a STOP and START condition                                | $t_{I2KHDX}$        | 1.3                  | —   | $\mu$ s |
| Noise margin at the LOW level for each connected device (including hysteresis)  | $V_{NL}$            | $0.1 \times OV_{DD}$ | —   | V       |
| Noise margin at the HIGH level for each connected device (including hysteresis) | $V_{NH}$            | $0.2 \times OV_{DD}$ | —   | V       |

**Notes:**

1. The symbols for timing specifications follow the pattern of  $t_{(first\ two\ letters\ of\ functional\ block)(signal)(state)(reference)(state)}$  for inputs and  $t_{(first\ two\ letters\ of\ functional\ block)(reference)(state)(signal)(state)}$  for outputs. For example,  $t_{I2DVKH}$  symbolizes I<sup>2</sup>C timing (I2) with respect to the time data input signals (D) reach the valid state (V) relative to the  $t_{I2C}$  clock reference (K) going to the high (H) state or setup time. Also,  $t_{I2SXKL}$  symbolizes I<sup>2</sup>C timing (I2) for the time that the data with respect to the start condition (S) goes invalid (X) relative to the  $t_{I2C}$  clock reference (K) going to the low (L) state or hold time. Also,  $t_{I2PVKH}$  symbolizes I<sup>2</sup>C timing (I2) for the time that the data with respect to the stop condition (P) reaches the valid state (V) relative to the  $t_{I2C}$  clock reference (K) going to the high (H) state or setup time. For rise and fall times, the latter convention is used with the appropriate letter: R (rise) or F (fall).
2. The device provides a hold time of at least 300 ns for the SDA signal (referred to the  $V_{IH(min)}$  of the SCL signal) to bridge the undefined region of the falling edge of SCL.
3. The maximum  $t_{I2DVKH}$  must be met only if the device does not stretch the LOW period ( $t_{I2CL}$ ) of the SCL signal.
4.  $C_B$  = capacitance of one bus line in pF.
- 5.)The device does not follow the "I<sup>2</sup>C-BUS Specifications" version 2.1 regarding the  $t_{I2CF}$  AC parameter.

Figure 32 provides the AC test load for the I<sup>2</sup>C.

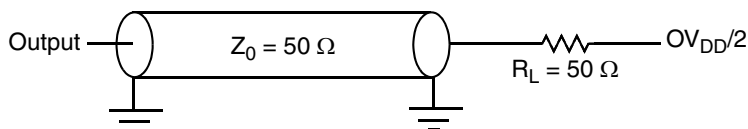

**Figure 32. I<sup>2</sup>C AC Test Load**

Figure 33 shows the AC timing diagram for the I<sup>2</sup>C bus.

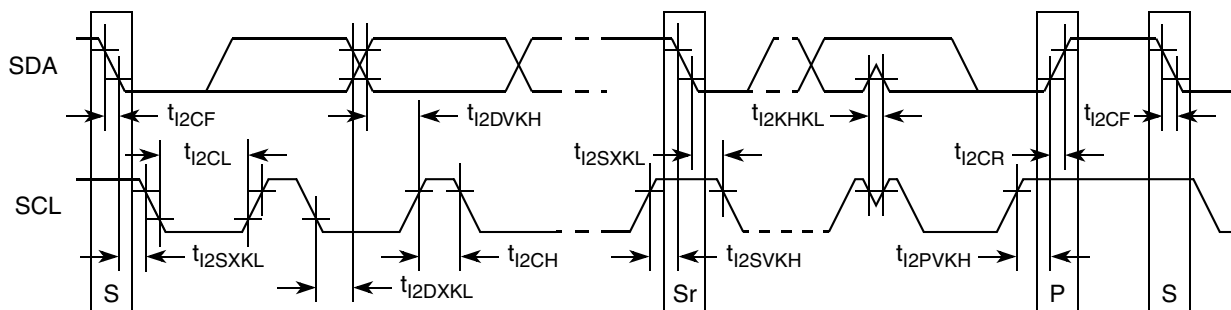

**Figure 33. I<sup>2</sup>C Bus AC Timing Diagram**

Table 53. SPI DC Electrical Characteristics (continued)

| Parameter           | Symbol   | Condition                  | Min | Max     | Unit    |
|---------------------|----------|----------------------------|-----|---------|---------|
| Input current       | $I_{IN}$ | —                          | —   | $\pm 5$ | $\mu A$ |
| Output high voltage | $V_{OH}$ | $I_{OH} = -8.0 \text{ mA}$ | 2.4 | —       | V       |
| Output low voltage  | $V_{OL}$ | $I_{OL} = 8.0 \text{ mA}$  | —   | 0.5     | V       |
| Output low voltage  | $V_{OL}$ | $I_{OL} = 3.2 \text{ mA}$  | —   | 0.4     | V       |

## 17.2 SPI AC Timing Specifications

Table 54 provides the SPI input and output AC timing specifications.

Table 54. SPI AC Timing Specifications<sup>1</sup>

| Parameter                                               | Symbol <sup>2</sup> | Min | Max | Unit |
|---------------------------------------------------------|---------------------|-----|-----|------|
| SPI outputs valid—Master mode (internal clock) delay    | $t_{NIKHOV}$        | —   | 6   | ns   |
| SPI outputs hold—Master mode (internal clock) delay     | $t_{NIKHOX}$        | 0.5 | —   | ns   |
| SPI outputs valid—Slave mode (external clock) delay     | $t_{NEKHOV}$        | —   | 8   | ns   |
| SPI outputs hold—Slave mode (external clock) delay      | $t_{NEKHOX}$        | 2   | —   | ns   |
| SPI inputs—Master mode (internal clock input setup time | $t_{NIIVKH}$        | 4   | —   | ns   |
| SPI inputs—Master mode (internal clock input hold time  | $t_{NIIXKH}$        | 0   | —   | ns   |
| SPI inputs—Slave mode (external clock) input setup time | $t_{NEIVKH}$        | 4   | —   | ns   |
| SPI inputs—Slave mode (external clock) input hold time  | $t_{NEIXKH}$        | 2   | —   | ns   |

### Notes:

- Output specifications are measured from the 50 percent level of the rising edge of CLKIN to the 50 percent level of the signal. Timings are measured at the pin.
- The symbols for timing specifications follow the pattern of  $t_{(\text{first two letters of functional block})(\text{signal})(\text{state})(\text{reference})(\text{state})}$  for inputs and  $t_{(\text{first two letters of functional block})(\text{reference})(\text{state})(\text{signal})(\text{state})}$  for outputs. For example,  $t_{NIKHOX}$  symbolizes the internal timing (NI) for the time SPICLK clock reference (K) goes to the high state (H) until outputs (O) are invalid (X).

Figure 37 provides the AC test load for the SPI.

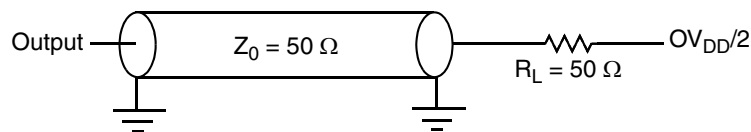
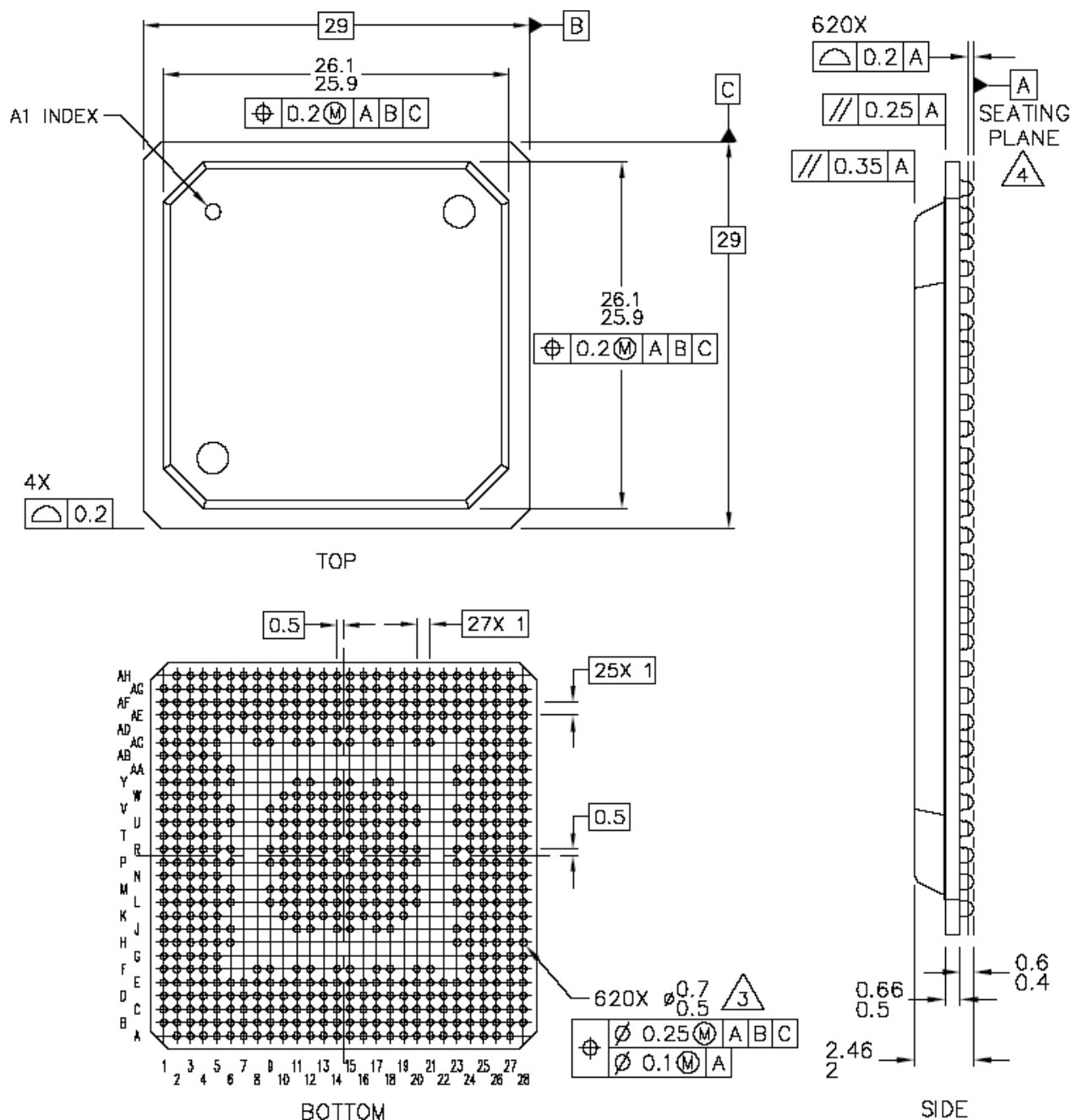


Figure 37. SPI AC Test Load

## 18.4 Mechanical Dimensions for the MPC8347EA PBGA

Figure 41 shows the mechanical dimensions and bottom surface nomenclature for the MPC8347EA, 620-PBGA package.



### Notes:

1. All dimensions are in millimeters.
2. Dimensioning and tolerancing per ASME Y14. 5M-1994.
3. Maximum solder ball diameter measured parallel to datum A.
4. Datum A, the seating plane, is determined by the spherical crowns of the solder balls.

**Figure 41. Mechanical Dimensions and Bottom Surface Nomenclature for the MPC8347EA PBGA**

Table 55. MPC8347EA (TBGA) Pinout Listing (continued)

| Signal                                          | Package Pin Number | Pin Type | Power Supply     | Notes |
|-------------------------------------------------|--------------------|----------|------------------|-------|
| LALÉ                                            | AK24               | O        | OV <sub>DD</sub> | —     |
| LGPL0/LSDA10/cfg_reset_source0                  | AP27               | I/O      | OV <sub>DD</sub> | —     |
| LGPL1/LSDWE/cfg_reset_source1                   | AL25               | I/O      | OV <sub>DD</sub> | —     |
| LGPL2/LSDRAS/LOE                                | AJ24               | O        | OV <sub>DD</sub> | —     |
| LGPL3/LSDCAS/cfg_reset_source2                  | AN27               | I/O      | OV <sub>DD</sub> | —     |
| LGPL4/LGTÁ/LUPWAIT/LPBSE                        | AP28               | I/O      | OV <sub>DD</sub> | 13    |
| LGPL5/cfg_clkin_div                             | AL26               | I/O      | OV <sub>DD</sub> | —     |
| LCKE                                            | AM27               | O        | OV <sub>DD</sub> | —     |
| LCLK[0:2]                                       | AN28, AK26, AP29   | O        | OV <sub>DD</sub> | —     |
| LSYNC_OUT                                       | AM12               | O        | OV <sub>DD</sub> | —     |
| LSYNC_IN                                        | AJ10               | I        | OV <sub>DD</sub> | —     |
| <b>General Purpose I/O Timers</b>               |                    |          |                  |       |
| GPIO1[0]/DMA_DREQ0/GTM1_TIN1/<br>GTM2_TIN2      | F24                | I/O      | OV <sub>DD</sub> | —     |
| GPIO1[1]/DMA_DACK0/GTM1_TGATE1/<br>GTM2_TGATE2  | E24                | I/O      | OV <sub>DD</sub> | —     |
| GPIO1[2]/DMA_DDONE0/GTM1_TOUT1                  | B25                | I/O      | OV <sub>DD</sub> | —     |
| GPIO1[3]/DMA_DREQ1/GTM1_TIN2/<br>GTM2_TIN1      | D24                | I/O      | OV <sub>DD</sub> | —     |
| GPIO1[4]/DMA_DACK1/GTM1_TGATE2/<br>GTM2_TGATE1  | A25                | I/O      | OV <sub>DD</sub> | —     |
| GPIO1[5]/DMA_DDONE1/GTM1_TOUT2/<br>GTM2_TOUT1   | B24                | I/O      | OV <sub>DD</sub> | —     |
| GPIO1[6]/DMA_DREQ2/GTM1_TIN3/<br>GTM2_TIN4      | A24                | I/O      | OV <sub>DD</sub> | —     |
| GPIO1[7]/DMA_DACK2/GTM1_TGATE3/<br>GTM2_TGATE4  | D23                | I/O      | OV <sub>DD</sub> | —     |
| GPIO1[8]/DMA_DDONE2/GTM1_TOUT3                  | B23                | I/O      | OV <sub>DD</sub> | —     |
| GPIO1[9]/DMA_DREQ3/GTM1_TIN4/<br>GTM2_TIN3      | A23                | I/O      | OV <sub>DD</sub> | —     |
| GPIO1[10]/DMA_DACK3/GTM1_TGATE4/<br>GTM2_TGATE3 | F22                | I/O      | OV <sub>DD</sub> | —     |
| GPIO1[11]/DMA_DDONE3/GTM1_TOUT4/<br>GTM2_TOUT3  | E22                | I/O      | OV <sub>DD</sub> | —     |
| <b>USB Port 1</b>                               |                    |          |                  |       |
| MPH1_D0_ENABLEN/DR_D0_ENABLEN                   | A26                | I/O      | OV <sub>DD</sub> | —     |
| MPH1_D1_SER_TXD/DR_D1_SER_TXD                   | B26                | I/O      | OV <sub>DD</sub> | —     |
| MPH1_D2_VMO_SE0/DR_D2_VMO_SE0                   | D25                | I/O      | OV <sub>DD</sub> | —     |

Table 55. MPC8347EA (TBGA) Pinout Listing (continued)

| Signal                                                         | Package Pin Number | Pin Type | Power Supply             | Notes |
|----------------------------------------------------------------|--------------------|----------|--------------------------|-------|
| $\overline{\text{IRQ}}[6]/\text{GPIO2}[18]/\text{CKSTOP\_OUT}$ | A21                | I/O      | $\text{OV}_{\text{DD}}$  | —     |
| $\overline{\text{IRQ}}[7]/\text{GPIO2}[19]/\text{CKSTOP\_IN}$  | C20                | I/O      | $\text{OV}_{\text{DD}}$  | —     |
| <b>Ethernet Management Interface</b>                           |                    |          |                          |       |
| EC_MDC                                                         | A7                 | O        | $\text{LV}_{\text{DD1}}$ | —     |
| EC_MDIO                                                        | E9                 | I/O      | $\text{LV}_{\text{DD1}}$ | 12    |
| <b>Gigabit Reference Clock</b>                                 |                    |          |                          |       |
| EC_GTX_CLK125                                                  | C8                 | I        | $\text{LV}_{\text{DD1}}$ | —     |
| <b>Three-Speed Ethernet Controller (Gigabit Ethernet 1)</b>    |                    |          |                          |       |
| TSEC1_COL/GPIO2[20]                                            | A17                | I/O      | $\text{OV}_{\text{DD}}$  | —     |
| TSEC1_CRS/GPIO2[21]                                            | F12                | I/O      | $\text{LV}_{\text{DD1}}$ | —     |
| TSEC1_GTX_CLK                                                  | D10                | O        | $\text{LV}_{\text{DD1}}$ | 3     |
| TSEC1_RX_CLK                                                   | A11                | I        | $\text{LV}_{\text{DD1}}$ | —     |
| TSEC1_RX_DV                                                    | B11                | I        | $\text{LV}_{\text{DD1}}$ | —     |
| TSEC1_RX_ER/GPIO2[26]                                          | B17                | I/O      | $\text{OV}_{\text{DD}}$  | —     |
| TSEC1_RXD[7:4]/GPIO2[22:25]                                    | B16, D16, E16, F16 | I/O      | $\text{OV}_{\text{DD}}$  | —     |
| TSEC1_RXD[3:0]                                                 | E10, A8, F10, B8   | I        | $\text{LV}_{\text{DD1}}$ | —     |
| TSEC1_TX_CLK                                                   | D17                | I        | $\text{OV}_{\text{DD}}$  | —     |
| TSEC1_TXD[7:4]/GPIO2[27:30]                                    | A15, B15, A14, B14 | I/O      | $\text{OV}_{\text{DD}}$  | —     |
| TSEC1_TXD[3:0]                                                 | A10, E11, B10, A9  | O        | $\text{LV}_{\text{DD1}}$ | 11    |
| TSEC1_TX_EN                                                    | B9                 | O        | $\text{LV}_{\text{DD1}}$ | —     |
| TSEC1_TX_ER/GPIO2[31]                                          | A16                | I/O      | $\text{OV}_{\text{DD}}$  | —     |
| <b>Three-Speed Ethernet Controller (Gigabit Ethernet 2)</b>    |                    |          |                          |       |
| TSEC2_COL/GPIO1[21]                                            | C14                | I/O      | $\text{OV}_{\text{DD}}$  | —     |
| TSEC2_CRS/GPIO1[22]                                            | D6                 | I/O      | $\text{LV}_{\text{DD2}}$ | —     |
| TSEC2_GTX_CLK                                                  | A4                 | O        | $\text{LV}_{\text{DD2}}$ | —     |
| TSEC2_RX_CLK                                                   | B4                 | I        | $\text{LV}_{\text{DD2}}$ | —     |
| TSEC2_RX_DV/GPIO1[23]                                          | E6                 | I/O      | $\text{LV}_{\text{DD2}}$ | —     |
| TSEC2_RXD[7:4]/GPIO1[26:29]                                    | A13, B13, C13, A12 | I/O      | $\text{OV}_{\text{DD}}$  | —     |
| TSEC2_RXD[3:0]/GPIO1[13:16]                                    | D7, A6, E8, B7     | I/O      | $\text{LV}_{\text{DD2}}$ | —     |
| TSEC2_RX_ER/GPIO1[25]                                          | D14                | I/O      | $\text{OV}_{\text{DD}}$  | —     |
| TSEC2_TXD[7]/GPIO1[31]                                         | B12                | I/O      | $\text{OV}_{\text{DD}}$  | —     |
| TSEC2_TXD[6]/DR_XCVR_TERM_SEL                                  | C12                | O        | $\text{OV}_{\text{DD}}$  | —     |
| TSEC2_TXD[5]/DR_UTMI_OPMODE1                                   | D12                | O        | $\text{OV}_{\text{DD}}$  | —     |
| TSEC2_TXD[4]/DR_UTMI_OPMODE0                                   | E12                | O        | $\text{OV}_{\text{DD}}$  | —     |

Table 55. MPC8347EA (TBGA) Pinout Listing (continued)

| Signal                                      | Package Pin Number | Pin Type | Power Supply      | Notes |
|---------------------------------------------|--------------------|----------|-------------------|-------|
| TSEC2_TXD[3:0]/GPIO1[17:20]                 | B5, A5, F8, B6     | I/O      | LV <sub>DD2</sub> | —     |
| TSEC2_TX_ER/GPIO1[24]                       | F14                | I/O      | OV <sub>DD</sub>  | —     |
| TSEC2_TX_EN/GPIO1[12]                       | C5                 | I/O      | LV <sub>DD2</sub> | 3     |
| TSEC2_TX_CLK/GPIO1[30]                      | E14                | I/O      | OV <sub>DD</sub>  | —     |
| <b>UART</b>                                 |                    |          |                   |       |
| UART_SOUT[1:2]/MSRCID[0:1]/LSRCID[0:1]      | AK27, AN29         | O        | OV <sub>DD</sub>  | —     |
| UART_SIN[1:2]/MSRCID[2:3]/LSRCID[2:3]       | AL28, AM29         | I/O      | OV <sub>DD</sub>  | —     |
| UART_CTS[1]/MSRCID4/LSRCID4                 | AP30               | I/O      | OV <sub>DD</sub>  | —     |
| UART_CTS[2]/MDVAL/ LDVAL                    | AN30               | I/O      | OV <sub>DD</sub>  | —     |
| UART_RTS[1:2]                               | AP31, AM30         | O        | OV <sub>DD</sub>  | —     |
| <b>I<sup>2</sup>C interface</b>             |                    |          |                   |       |
| IIC1_SDA                                    | AK29               | I/O      | OV <sub>DD</sub>  | 2     |
| IIC1_SCL                                    | AP32               | I/O      | OV <sub>DD</sub>  | 2     |
| IIC2_SDA                                    | AN31               | I/O      | OV <sub>DD</sub>  | 2     |
| IIC2_SCL                                    | AM31               | I/O      | OV <sub>DD</sub>  | 2     |
| <b>SPI</b>                                  |                    |          |                   |       |
| SPIMOSI/ $\overline{\text{LCS}}$ [6]        | AN32               | I/O      | OV <sub>DD</sub>  | —     |
| SPIMISO/ $\overline{\text{LCS}}$ [7]        | AP33               | I/O      | OV <sub>DD</sub>  | —     |
| SPICLK                                      | AK30               | I/O      | OV <sub>DD</sub>  | —     |
| SPISEL                                      | AL31               | I        | OV <sub>DD</sub>  | —     |
| <b>Clocks</b>                               |                    |          |                   |       |
| PCI_CLK_OUT[0:2]                            | AN9, AP9, AM10     | O        | OV <sub>DD</sub>  | —     |
| PCI_CLK_OUT[3]/ $\overline{\text{LCS}}$ [6] | AN10               | O        | OV <sub>DD</sub>  | —     |
| PCI_CLK_OUT[4]/ $\overline{\text{LCS}}$ [7] | AJ11               | O        | OV <sub>DD</sub>  | —     |
| PCI_SYNC_IN/PCI_CLOCK                       | AK12               | I        | OV <sub>DD</sub>  | —     |
| PCI_SYNC_OUT                                | AP11               | O        | OV <sub>DD</sub>  | 3     |
| RTC/PIT_CLOCK                               | AM32               | I        | OV <sub>DD</sub>  | —     |
| CLKIN                                       | AM9                | I        | OV <sub>DD</sub>  | —     |
| <b>JTAG</b>                                 |                    |          |                   |       |
| TCK                                         | E20                | I        | OV <sub>DD</sub>  | —     |
| TDI                                         | F20                | I        | OV <sub>DD</sub>  | 4     |
| TDO                                         | B20                | O        | OV <sub>DD</sub>  | 3     |
| TMS                                         | A20                | I        | OV <sub>DD</sub>  | 4     |
| $\overline{\text{TRST}}$                    | B19                | I        | OV <sub>DD</sub>  | 4     |

Table 56. MPC8347EA (PBGA) Pinout Listing (continued)

| Signal                                     | Package Pin Number | Pin Type | Power Supply     | Notes |
|--------------------------------------------|--------------------|----------|------------------|-------|
| <b>I<sup>2</sup>C interface</b>            |                    |          |                  |       |
| IIC1_SDA                                   | E5                 | I/O      | OV <sub>DD</sub> | 2     |
| IIC1_SCL                                   | A6                 | I/O      | OV <sub>DD</sub> | 2     |
| IIC2_SDA                                   | B6                 | I/O      | OV <sub>DD</sub> | 2     |
| IIC2_SCL                                   | E7                 | I/O      | OV <sub>DD</sub> | 2     |
| <b>SPI</b>                                 |                    |          |                  |       |
| SPIMOSI/ $\overline{\text{LCS}}[6]$        | D7                 | I/O      | OV <sub>DD</sub> | —     |
| SPIMISO/ $\overline{\text{LCS}}[7]$        | C7                 | I/O      | OV <sub>DD</sub> | —     |
| SPICLK                                     | B7                 | I/O      | OV <sub>DD</sub> | —     |
| SPISEL                                     | A7                 | I        | OV <sub>DD</sub> | —     |
| <b>Clocks</b>                              |                    |          |                  |       |
| PCI_CLK_OUT[0:2]                           | Y1, W3, W2         | O        | OV <sub>DD</sub> | —     |
| PCI_CLK_OUT[3]/ $\overline{\text{LCS}}[6]$ | W1                 | O        | OV <sub>DD</sub> | —     |
| PCI_CLK_OUT[4]/ $\overline{\text{LCS}}[7]$ | V3                 | O        | OV <sub>DD</sub> | —     |
| PCI_SYNC_IN/PCI_CLOCK                      | U4                 | I        | OV <sub>DD</sub> | —     |
| PCI_SYNC_OUT                               | U5                 | O        | OV <sub>DD</sub> | 3     |
| RTC/PIT_CLOCK                              | E9                 | I        | OV <sub>DD</sub> | —     |
| CLKIN                                      | W5                 | I        | OV <sub>DD</sub> | —     |
| <b>JTAG</b>                                |                    |          |                  |       |
| TCK                                        | H27                | I        | OV <sub>DD</sub> | —     |
| TDI                                        | H28                | I        | OV <sub>DD</sub> | 4     |
| TDO                                        | M24                | O        | OV <sub>DD</sub> | 3     |
| TMS                                        | J27                | I        | OV <sub>DD</sub> | 4     |
| $\overline{\text{TRST}}$                   | K26                | I        | OV <sub>DD</sub> | 4     |
| <b>Test</b>                                |                    |          |                  |       |
| TEST                                       | F28                | I        | OV <sub>DD</sub> | 6     |
| TEST_SEL                                   | T3                 | I        | OV <sub>DD</sub> | 6     |
| <b>PMC</b>                                 |                    |          |                  |       |
| $\overline{\text{QUIESCE}}$                | K27                | O        | OV <sub>DD</sub> | —     |
| <b>System Control</b>                      |                    |          |                  |       |
| $\overline{\text{PORESET}}$                | K28                | I        | OV <sub>DD</sub> | —     |
| $\overline{\text{HRESET}}$                 | M25                | I/O      | OV <sub>DD</sub> | 1     |
| $\overline{\text{SRESET}}$                 | L27                | I/O      | OV <sub>DD</sub> | 2     |



Table 56. MPC8347EA (PBGA) Pinout Listing (continued)

| Signal                          | Package Pin Number                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  | Pin Type                                                 | Power Supply      | Notes |
|---------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------|-------------------|-------|
| <b>Thermal Management</b>       |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |                                                          |                   |       |
| THERM0                          | B15                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 | I                                                        | —                 | 8     |
| <b>Power and Ground Signals</b> |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |                                                          |                   |       |
| AV <sub>DD1</sub>               | C15                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 | Power for e300 PLL (1.2 V) nominal, 1.3 V for 667 MHz)   | AV <sub>DD1</sub> | —     |
| AV <sub>DD2</sub>               | U1                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  | Power for system PLL (1.2 V) nominal, 1.3 V for 667 MHz) | AV <sub>DD2</sub> | —     |
| AV <sub>DD3</sub>               | AF9                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 | Power for DDR DLL (1.2 V nominal, 1.3 V for 667 MHz)     |                   | —     |
| AV <sub>DD4</sub>               | U2                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  | Power for LBIU DLL (1.2 V nominal, 1.3 V for 667 MHz)    | AV <sub>DD4</sub> | —     |
| GND                             | A2, B1, B2, D10, D18, E6, E14, E22, F9, F12, F15, F18, F21, F24, G5, H6, J23, L4, L6, L12, L13, L14, L15, L16, L17, M11, M12, M13, M14, M15, M16, M17, M18, M23, N11, N12, N13, N14, N15, N16, N17, N18, P6, P11, P12, P13, P14, P15, P16, P17, P18, P24, R5, R11, R12, R13, R14, R15, R16, R17, R18, R23, T11, T12, T13, T14, T15, T16, T17, T18, U6, U11, U12, U13, U14, U15, U16, U17, U18, V12, V13, V14, V15, V16, V17, V23, V25, W4, Y6, AA23, AB24, AC5, AC8, AC11, AC14, AC17, AC20, AD9, AD15, AD21, AE12, AE18, AF3, AF26 | —                                                        | —                 | —     |
| GV <sub>DD</sub>                | U9, V9, W10, W19, Y11, Y12, Y14, Y15, Y17, Y18, AA6, AB5, AC9, AC12, AC15, AC18, AC21, AC24, AD6, AD8, AD14, AD20, AE5, AE11, AE17, AG2, AG27                                                                                                                                                                                                                                                                                                                                                                                       | Power for DDR DRAM I/O voltage (2.5 V)                   | GV <sub>DD</sub>  | —     |

Table 56. MPC8347EA (PBGA) Pinout Listing (continued)

| Signal            | Package Pin Number                                                                                                                                                                                                   | Pin Type                                                                                   | Power Supply          | Notes |
|-------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------|-----------------------|-------|
| LV <sub>DD1</sub> | U20, W25                                                                                                                                                                                                             | Power for three-speed Ethernet #1 and for Ethernet management interface I/O (2.5 V, 3.3 V) | LV <sub>DD1</sub>     | —     |
| LV <sub>DD2</sub> | V20, Y23                                                                                                                                                                                                             | Power for three-speed Ethernet #2 I/O (2.5 V, 3.3 V)                                       | LV <sub>DD2</sub>     | —     |
| V <sub>DD</sub>   | J11, J12, J15, K10, K11, K12, K13, K14, K15, K16, K17, K18, K19, L10, L11, L18, L19, M10, M19, N10, N19, P9, P10, P19, R10, R19, R20, T10, T19, U10, U19, V10, V11, V18, V19, W11, W12, W13, W14, W15, W16, W17, W18 | Power for core (1.2 V)                                                                     | V <sub>DD</sub>       | —     |
| OV <sub>DD</sub>  | B27, D3, D11, D19, E15, E23, F5, F8, F11, F14, F17, F20, G24, H23, H24, J6, J14, J17, J18, K4, L9, L20, L23, L25, M6, M9, M20, P5, P20, P23, R6, R9, R24, U23, V4, V6                                                | PCI, 10/100 Ethernet, and other standard (3.3 V)                                           | OV <sub>DD</sub>      | —     |
| MVREF1            | AF19                                                                                                                                                                                                                 | I                                                                                          | DDR reference voltage | —     |
| MVREF2            | AE10                                                                                                                                                                                                                 | I                                                                                          | DDR reference voltage | —     |
| No Connection     |                                                                                                                                                                                                                      |                                                                                            |                       |       |
| NC                | V1, V2, V5                                                                                                                                                                                                           | —                                                                                          | —                     | —     |

**Notes:**

1. This pin is an open-drain signal. A weak pull-up resistor (1 k $\Omega$ ) should be placed on this pin to OV<sub>DD</sub>.
2. This pin is an open-drain signal. A weak pull-up resistor (2–10 k $\Omega$ ) should be placed on this pin to OV<sub>DD</sub>.
3. During reset, this output is actively driven rather than three-stated.
4. These JTAG pins have weak internal pull-up P-FETs that are always enabled.
5. This pin should have a weak pull-up if the chip is in PCI host mode. Follow the PCI specifications.
6. This pin must always be tied to GND.
7. This pin must always be left not connected.
8. Thermal sensitive resistor.
9. It is recommended that MDIC0 be tied to GRD using an 18  $\Omega$  resistor and MDIC1 be tied to DDR power using an 18  $\Omega$  resistor.
10. TSEC1\_TXD[3] is required an external pull-up resistor. For proper functionality of the device, this pin must be pulled up or actively driven high during a hard reset. No external pull-down resistors are allowed to be attached to this net.
11. A weak pull-up resistor (2–10 k $\Omega$ ) should be placed on this pin to LV<sub>DD1</sub>.
12. For systems that boot from local bus (GPCM)-controlled NOR flash, a pullup on LGPL4 is required.

Table 62. CSB Frequency Options for Agent Mode

| CFG_CLKIN_DIV<br>at Reset <sup>1</sup> | SPMF | csb_clk :<br>Input Clock Ratio <sup>2</sup> | Input Clock Frequency (MHz) <sup>2</sup> |     |       |       |     |     |
|----------------------------------------|------|---------------------------------------------|------------------------------------------|-----|-------|-------|-----|-----|
|                                        |      |                                             | 16.67                                    | 25  | 33.33 | 66.67 |     |     |
|                                        |      |                                             | csb_clk Frequency (MHz)                  |     |       |       |     |     |
| Low                                    | 0010 | 2 : 1                                       |                                          |     |       | 133   |     |     |
| Low                                    | 0011 | 3 : 1                                       |                                          |     |       | 100   | 200 |     |
| Low                                    | 0100 | 4 : 1                                       |                                          |     |       | 100   | 133 | 266 |
| Low                                    | 0101 | 5 : 1                                       |                                          |     |       | 125   | 166 | 333 |
| Low                                    | 0110 | 6 : 1                                       | 100                                      | 150 | 200   |       |     |     |
| Low                                    | 0111 | 7 : 1                                       | 116                                      | 175 | 233   |       |     |     |
| Low                                    | 1000 | 8 : 1                                       | 133                                      | 200 | 266   |       |     |     |
| Low                                    | 1001 | 9 : 1                                       | 150                                      | 225 | 300   |       |     |     |
| Low                                    | 1010 | 10 : 1                                      | 166                                      | 250 | 333   |       |     |     |
| Low                                    | 1011 | 11 : 1                                      | 183                                      | 275 |       |       |     |     |
| Low                                    | 1100 | 12 : 1                                      | 200                                      | 300 |       |       |     |     |
| Low                                    | 1101 | 13 : 1                                      | 216                                      | 325 |       |       |     |     |
| Low                                    | 1110 | 14 : 1                                      | 233                                      |     |       |       |     |     |
| Low                                    | 1111 | 15 : 1                                      | 250                                      |     |       |       |     |     |
| Low                                    | 0000 | 16 : 1                                      | 266                                      |     |       |       |     |     |
| High                                   | 0010 | 4 : 1                                       |                                          | 100 | 133   | 266   |     |     |
| High                                   | 0011 | 6 : 1                                       | 100                                      | 150 | 200   |       |     |     |
| High                                   | 0100 | 8 : 1                                       | 133                                      | 200 | 266   |       |     |     |
| High                                   | 0101 | 10 : 1                                      | 166                                      | 250 | 333   |       |     |     |
| High                                   | 0110 | 12 : 1                                      | 200                                      | 300 |       |       |     |     |
| High                                   | 0111 | 14 : 1                                      | 233                                      |     |       |       |     |     |
| High                                   | 1000 | 16 : 1                                      | 266                                      |     |       |       |     |     |

<sup>1</sup> CFG\_CLKIN\_DIV doubles *csb\_clk* if set high.

<sup>2</sup> CLKIN is the input clock in host mode; PCI\_CLK is the input clock in agent mode.

DDR2 memory may be used at 133 MHz provided that the memory components are specified for operation at this frequency.

## 19.2 Core PLL Configuration

RCWL[COREPLL] selects the ratio between the internal coherent system bus clock (*csb\_clk*) and the e300 core clock (*core\_clk*). Table 63 shows the encodings for RCWL[COREPLL]. COREPLL values that are not listed in Table 63 should be considered as reserved.

### NOTE

Core VCO frequency = core frequency × VCO divider

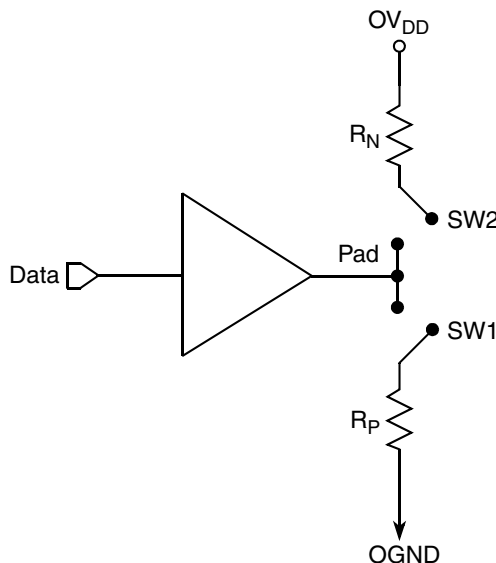
VCO divider must be set properly so that the core VCO frequency is in the range of 800–1800 MHz.

**Table 63. e300 Core PLL Configuration**

| RCWL[COREPLL] |             |   | <i>core_clk</i> : <i>csb_clk</i> Ratio                         | VCO Divider <sup>1</sup>                                       |
|---------------|-------------|---|----------------------------------------------------------------|----------------------------------------------------------------|
| 0–1           | 2–5         | 6 |                                                                |                                                                |
| <b>nn</b>     | <b>0000</b> | n | PLL bypassed<br>(PLL off, <i>csb_clk</i> clocks core directly) | PLL bypassed<br>(PLL off, <i>csb_clk</i> clocks core directly) |
| <b>00</b>     | <b>0001</b> | 0 | 1:1                                                            | 2                                                              |
| <b>01</b>     | <b>0001</b> | 0 | 1:1                                                            | 4                                                              |
| <b>10</b>     | <b>0001</b> | 0 | 1:1                                                            | 8                                                              |
| <b>11</b>     | <b>0001</b> | 0 | 1:1                                                            | 8                                                              |
| <b>00</b>     | <b>0001</b> | 1 | 1.5:1                                                          | 2                                                              |
| <b>01</b>     | <b>0001</b> | 1 | 1.5:1                                                          | 4                                                              |
| <b>10</b>     | <b>0001</b> | 1 | 1.5:1                                                          | 8                                                              |
| <b>11</b>     | <b>0001</b> | 1 | 1.5:1                                                          | 8                                                              |
| <b>00</b>     | <b>0010</b> | 0 | 2:1                                                            | 2                                                              |
| <b>01</b>     | <b>0010</b> | 0 | 2:1                                                            | 4                                                              |
| <b>10</b>     | <b>0010</b> | 0 | 2:1                                                            | 8                                                              |
| <b>11</b>     | <b>0010</b> | 0 | 2:1                                                            | 8                                                              |
| <b>00</b>     | <b>0010</b> | 1 | 2.5:1                                                          | 2                                                              |
| <b>01</b>     | <b>0010</b> | 1 | 2.5:1                                                          | 4                                                              |
| <b>10</b>     | <b>0010</b> | 1 | 2.5:1                                                          | 8                                                              |
| <b>11</b>     | <b>0010</b> | 1 | 2.5:1                                                          | 8                                                              |
| <b>00</b>     | <b>0011</b> | 0 | 3:1                                                            | 2                                                              |
| <b>01</b>     | <b>0011</b> | 0 | 3:1                                                            | 4                                                              |
| <b>10</b>     | <b>0011</b> | 0 | 3:1                                                            | 8                                                              |
| <b>11</b>     | <b>0011</b> | 0 | 3:1                                                            | 8                                                              |

<sup>1</sup> Core VCO frequency = core frequency × VCO divider. The VCO divider must be set properly so that the core VCO frequency is in the range of 800–1800 MHz.

$OV_{DD}/2$ .  $R_P$  then becomes the resistance of the pull-up devices.  $R_P$  and  $R_N$  are designed to be close to each other in value. Then,  $Z_0 = (R_P + R_N) \div 2$ .



**Figure 44. Driver Impedance Measurement**

Two measurements give the value of this resistance and the strength of the driver current source. First, the output voltage is measured while driving logic 1 without an external differential termination resistor. The measured voltage is  $V_1 = R_{source} \times I_{source}$ . Second, the output voltage is measured while driving logic 1 with an external precision differential termination resistor of value  $R_{term}$ . The measured voltage is  $V_2 = (1 \div (1/R_1 + 1/R_2)) \times I_{source}$ . Solving for the output impedance gives  $R_{source} = R_{term} \times (V_1 \div V_2 - 1)$ . The drive current is then  $I_{source} = V_1 \div R_{source}$ .

[Table 69](#) summarizes the signal impedance targets. The driver impedance are targeted at minimum  $V_{DD}$ , nominal  $OV_{DD}$ , 105°C.

**Table 69. Impedance Characteristics**

| Impedance    | Local Bus, Ethernet, DUART, Control, Configuration, Power Management | PCI Signals (Not Including PCI Output Clocks) | PCI Output Clocks (Including PCI_SYNC_OUT) | DDR DRAM  | Symbol     | Unit |
|--------------|----------------------------------------------------------------------|-----------------------------------------------|--------------------------------------------|-----------|------------|------|
| $R_N$        | 42 Target                                                            | 25 Target                                     | 42 Target                                  | 20 Target | $Z_0$      | W    |
| $R_P$        | 42 Target                                                            | 25 Target                                     | 42 Target                                  | 20 Target | $Z_0$      | W    |
| Differential | NA                                                                   | NA                                            | NA                                         | NA        | $Z_{DIFF}$ | W    |

**Note:** Nominal supply voltages. See [Table 1](#),  $T_j = 105^\circ\text{C}$ .

## 21.6 Configuration Pin Multiplexing

The MPC8347EA power-on configuration options can be set through external pull-up or pull-down resistors of 4.7 kΩ on certain output pins (see the customer-visible configuration pins). These pins are used as output only pins in normal operation.